

STM32L4P5xx/Q5xx device errata

Applicability

This document applies to the part numbers of STM32L4P5xx/Q5xx devices and the device variants as stated in this page.

It gives a summary and a description of the device errata, with respect to the device datasheet and reference manual RM0432.

Deviation of the real device behavior from the intended device behavior is considered to be a device limitation. Deviation of the description in the reference manual or the datasheet from the intended device behavior is considered to be a documentation erratum. The term “*errata*” applies both to limitations and documentation errata.

Table 1. Device summary

Reference	Part numbers
STM32L4P5xx	STM32L4P5ZG, STM32L4P5ZE, STM32L4P5VG, STM32L4P5VE, STM32L4P5RG, STM32L4P5RE, STM32L4P5QG, STM32L4P5QE, STM32L4P5CG, STM32L4P5CE, STM32L4P5AG, STM32L4P5AE
STM32L4Q5xx	STM32L4Q5ZG, STM32L4Q5VG, STM32L4Q5RG, STM32L4Q5QG, STM32L4Q5CG, STM32L4Q5AG

Table 2. Device variants

Reference	Silicon revision codes	
	Device marking ⁽¹⁾	REV_ID ⁽²⁾
STM32L4P5xx/Q5xx	Z	0x1001

1. Refer to the device datasheet for how to identify this code on different types of package.
2. REV_ID[15:0] bitfield of DBGMCU_IDCODE register.

1 Summary of device errata

The following table gives a quick reference to the STM32L4P5xx/Q5xx device limitations and their status:

A = workaround available

N = no workaround available

P = partial workaround available

Applicability of a workaround may depend on specific conditions of target application. Adoption of a workaround may cause restrictions to target application. Workaround for a limitation is deemed partial if it only reduces the rate of occurrence and/or consequences of the limitation, or if it is fully effective for only a subset of instances on the device or in only a subset of operating modes, of the function concerned.

Table 3. Summary of device limitations

Function	Section	Limitation	Status
			Rev. Z
Core	2.1.1	Interrupted loads to SP can cause erroneous behavior	A
System	2.2.1	Full JTAG configuration without NJTRST pin cannot be used	A
	2.2.2	Data cache might be corrupted during Flash memory read-while-write operation	A
	2.2.3	HSE oscillator long startup at low voltage	P
	2.2.4	FLASH_ECCR corrupted upon reset or power-down occurring during Flash memory program or erase operation	A
DMA	2.3.1	DMA disable failure and error flag omission upon simultaneous transfer error and global flag clear	A
DMAMUX	2.4.1	SOFx not asserted when writing into DMAMUX_CFR register	N
	2.4.2	OFx not asserted for trigger event coinciding with last DMAMUX request	N
	2.4.3	OFx not asserted when writing into DMAMUX_RGCFR register	N
	2.4.4	Wrong input DMA request routed upon specific DMAMUX_CxCR register write coinciding with synchronization event	A
FMC	2.5.1	Dummy read cycles inserted when reading synchronous memories	N
	2.5.2	Wrong data read from a busy NAND memory	A
OCTOSPI	2.6.1	Spurious interrupt in AND-match polling mode with full data masking	A
	2.6.2	Odd address alignment and odd byte number not supported at specific conditions	A
	2.6.3	Data not sampled correctly on reads without DQS and with less than two cycles before the data phase	A
	2.6.4	Byte possibly dropped during an SDR read in clock mode 3 when a transfer gets automatically split	A
	2.6.5	Single, dual and quad modes not functional with DQS input enabled	N
	2.6.6	Additional bytes read in indirect mode with DQS input enabled when data length is too short	A
OCTOSPIM	2.7.1	Unaligned write access to OCTOSPIM configuration registers failing	A
ADC	2.8.1	New context conversion initiated without waiting for trigger when writing new context in ADC_JSQR with JQDIS = 0 and JQM = 0	A
	2.8.2	Two consecutive context conversions fail when writing new context in ADC_JSQR just after previous context completion with JQDIS = 0 and JQM = 0	A
	2.8.3	Unexpected regular conversion when two consecutive injected conversions are performed in Dual interleaved mode	A

Function	Section	Limitation	Status
			Rev. Z
ADC	2.8.4	Wrong ADC result if conversion done late after calibration or previous conversion	A
	2.8.5	Wrong ADC differential conversion result for channel 5	A
DAC	2.9.1	Invalid DAC channel analog output if the DAC channel MODE bitfield is programmed before DAC initialization	A
	2.9.2	DMA underrun flag not set when an internal trigger is detected on the clock cycle of the DMA request acknowledge	N
COMP	2.10.1	Comparator outputs cannot be configured in open-drain	N
TIM	2.12.1	One-pulse mode trigger not detected in master-slave reset + trigger configuration	P
	2.12.2	HSE/32 is not available for TIM16 input capture if RTC clock is disabled or other than HSE	A
LPTIM	2.13.1	MCU may remain stuck in LPTIM interrupt when entering Stop mode	A
	2.13.2	ARRM and CMPM flags are not set when APB clock is slower than kernel clock	P
	2.13.3	MCU may remain stuck in LPTIM interrupt when clearing event flag	P
	2.13.4	LPTIM1 outputs cannot be configured as open-drain	N
RTC and TAMP	2.14.1	Alarm flag may be repeatedly set when the core is stopped in debug	N
	2.14.2	RTC_REFIN and RTC_OUT on PB2 not operating in Stop 2 mode	P
I2C	2.15.1	Wrong data sampling when data setup time (t _{SU;DAT}) is shorter than one I2C kernel clock period	P
	2.15.2	Spurious bus error detection in master mode	A
	2.15.3	OVR flag not set in underrun condition	N
	2.15.4	Transmission stalled after first byte transfer	A
USART	2.16.1	Anticipated end-of-transmission signaling in SPI slave mode	A
	2.16.2	Data corruption due to noisy receive line	N
LPUART	2.17.1	LPUART1 outputs cannot be configured as open-drain	N
SPI	2.18.1	BSY bit may stay high when SPI is disabled	A
	2.18.2	BSY bit may stay high at the end of data transfer in slave mode	A
SAI	2.19.1	Last SAI_MCLK clock pulse truncated upon disabling SAI master	A
bxCAN	2.20.1	bxCAN time-triggered communication mode not supported	N
OTG_FS	2.21.1	Host packet transmission may hang when connecting through a hub to a low-speed device	N

The following table gives a quick reference to the documentation errata.

Table 4. Summary of device documentation errata

Function	Section	Documentation erratum
HASH	2.11.1	Superseded suspend sequence for data loaded by DMA
	2.11.2	Superseded suspend sequence for data loaded by the CPU

2 Description of device errata

The following sections describe limitations of the applicable devices with Arm® core and provide workarounds if available. They are grouped by device functions.

Note: Arm is a registered trademark of Arm Limited (or its subsidiaries) in the US and/or elsewhere.



2.1 Core

Reference manual and errata notice for the Arm® Cortex®-M4 FPU core revision r0p1 is available from <http://infocenter.arm.com>.

2.1.1 Interrupted loads to SP can cause erroneous behavior

This limitation is registered under Arm ID number 752770 and classified into “Category B”. Its impact to the device is minor.

Description

If an interrupt occurs during the data-phase of a single word load to the stack-pointer (SP/R13), erroneous behavior can occur. In all cases, returning from the interrupt will result in the load instruction being executed an additional time. For all instructions performing an update to the base register, the base register will be erroneously updated on each execution, resulting in the stack-pointer being loaded from an incorrect memory location.

The affected instructions that can result in the load transaction being repeated are:

- LDR SP, [Rn],#imm
- LDR SP, [Rn,#imm]!
- LDR SP, [Rn,#imm]
- LDR SP, [Rn]
- LDR SP, [Rn,Rm]

The affected instructions that can result in the stack-pointer being loaded from an incorrect memory address are:

- LDR SP,[Rn],#imm
- LDR SP,[Rn,#imm]!

As compilers do not generate these particular instructions, the limitation is only likely to occur with hand-written assembly code.

Workaround

Both issues may be worked around by replacing the direct load to the stack-pointer, with an intermediate load to a general-purpose register followed by a move to the stack-pointer.

2.2 System

2.2.1 Full JTAG configuration without NJTRST pin cannot be used

Description

When using the JTAG debug port in Debug mode, the connection with the debugger is lost if the NJTRST pin (PB4) is used as a GPIO. Only the 4-wire JTAG port configuration is impacted.

Workaround

Use the SWD debug port instead of the full 4-wire JTAG port.

2.2.2 Data cache might be corrupted during Flash memory read-while-write operation

Description

When a write to the internal Flash memory is done, the data cache is normally updated to reflect the data value update. During this data cache update, a read to the other Flash memory bank may occur; this read can corrupt the data cache content and subsequent read operations at the same address (cache hits) will be corrupted.

This limitation only occurs in dual bank mode, when reading (data access or code execution) from one bank while writing to the other bank with data cache enabled.

Workaround

When the application is performing data accesses in both Flash memory banks, the data cache must be disabled by resetting the DCEN bit before any write to the Flash memory. Before enabling the data cache again, it must be reset by setting and then resetting the DCRST bit.

Code example:

```

/* Disable data cache */
__HAL_FLASH_DATA_CACHE_DISABLE();

/* Set PG bit */
SET_BIT(FLASH->CR, FLASH_CR_PG);

/* Program the Flash word */
WriteFlash(Address, Data);

/* Reset data cache */
__HAL_FLASH_DATA_CACHE_RESET();

/* Enable data cache */
__HAL_FLASH_DATA_CACHE_ENABLE();

```

2.2.3 HSE oscillator long startup at low voltage

Description

When V_{DD} is below 2.7 V, the HSE oscillator may take longer than specified to start up. Several hundred milliseconds might elapse before the HSERDY flag in the RCC_CR register is set.

Workaround

The following sequence is recommended:

1. Configure PH0 and PH1 as standard GPIOs in output mode and low-level state.
2. Enable the HSE oscillator.

2.2.4 FLASH_ECCR corrupted upon reset or power-down occurring during Flash memory program or erase operation

Description

Reset or power-down occurring during a Flash memory location program or erase operation, followed by a read of the same memory location, may lead to a corruption of the FLASH_ECCR register content.

Workaround

Under such condition, erase the page(s) corresponding to the Flash memory location.

2.3 DMA

2.3.1 DMA disable failure and error flag omission upon simultaneous transfer error and global flag clear

Description

Upon a data transfer error in a DMA channel x, both the specific TEIFx and the global GIFx flags are raised and the channel x is normally automatically disabled. However, if in the same clock cycle the software clears the GIFx flag (by setting the CGIFx bit of the DMA_IFCR register), the automatic channel disable fails and the TEIFx flag is not raised.

This issue does not occur with ST's HAL software that does not use and clear the GIFx flag, but uses and clears the HTIFx, TCIFx, and TEIFx specific event flags instead.

Workaround

Do not clear GIFx flags. Instead, use HTIFx, TCIFx, and TEIFx specific event flags and their corresponding clear bits.

2.4 DMAMUX

2.4.1 SOFx not asserted when writing into DMAMUX_CFR register

Description

The SOFx flag of the DMAMUX_CSR status register is not asserted if overrun from another DMAMUX channel occurs when the software writes into the DMAMUX_CFR register.

This can happen when multiple DMA channels operate in synchronization mode, and when overrun can occur from more than one channel. As the SOFx flag clear requires a write into the DMAMUX_CFR register (to set the corresponding CSOFx bit), overrun occurring from another DMAMUX channel operating during that write operation fails to raise its corresponding SOFx flag.

Workaround

None. Avoid the use of synchronization mode for concurrent DMAMUX channels, if at least two of them potentially generate synchronization overrun.

2.4.2 OFx not asserted for trigger event coinciding with last DMAMUX request

Description

In the DMAMUX request generator, a trigger event detected in a critical instant of the last-generated DMAMUX request being served by the DMA controller does not assert the corresponding trigger overrun flag OFx. The critical instant is the clock cycle at the very end of the trigger overrun condition.

Additionally, upon the following trigger event, one single DMA request is issued by the DMAMUX request generator, regardless of the programmed number of DMA requests to generate.

The failure only occurs if the number of requests to generate is set to more than two ($GNBREQ[4:0] > 00001$).

Workaround

Make the trigger period longer than the duration required for serving the programmed number of DMA requests, so as to avoid the trigger overrun condition from occurring on the very last DMA data transfer.

2.4.3 OFx not asserted when writing into DMAMUX_RGCFR register

Description

The OFx flag of the DMAMUX_RGSR status register is not asserted if an overrun from another DMAMUX request generator channel occurs when the software writes into the DMAMUX_RGCFR register. This can happen when multiple DMA channels operate with the DMAMUX request generator, and when an overrun can occur from more than one request generator channel. As the OFx flag clear requires a write into the DMAMUX_RGCFR register (to set the corresponding COFx bit), an overrun occurring in another DMAMUX channel operating with another request generator channel during that write operation fails to raise the corresponding OFx flag.

Workaround

None. Avoid the use of request generator mode for concurrent DMAMUX channels, if at least two channels are potentially generating a request generator overrun.

2.4.4 Wrong input DMA request routed upon specific DMAMUX_CxCR register write coinciding with synchronization event

Description

If a write access into the DMAMUX_CxCR register having the SE bit at zero and SPOL[1:0] bitfield at a value other than 00:

- sets the SE bit (enables synchronization),
- modifies the values of the DMAREQ_ID[5:0] and SYNC_ID[4:0] bitfields, and
- does not modify the SPOL[1:0] bitfield,

and if a synchronization event occurs on the previously selected synchronization input exactly two AHB clock cycles before this DMAMUX_CxCR write, then the input DMA request selected by the DMAREQ_ID[5:0] value before that write is routed.

Workaround

Ensure that the SPOL[1:0] bitfield is at 00 whenever the SE bit is 0. When enabling synchronization by setting the SE bit, always set the SPOL[1:0] bitfield to a value other than 00 with the same write operation into the DMAMUX_CxCR register.

2.5 FMC

2.5.1 Dummy read cycles inserted when reading synchronous memories

Description

When performing a burst read access from a synchronous memory, two dummy read accesses are performed at the end of the burst cycle whatever the type of burst access.

The extra data values read are not used by the FMC and there is no functional failure.

Workaround

None.

2.5.2 Wrong data read from a busy NAND memory

Description

When a read command is issued to the NAND memory, the R/B signal gets activated upon the de-assertion of the chip select. If a read transaction is pending, the NAND controller might not detect the R/B signal (connected to NWAIT) previously asserted and sample a wrong data. This problem occurs only when the MEMSET timing is configured to 0x00 or when ATTHOLD timing is configured to 0x00 or 0x01.

Workaround

Either configure MEMSET timing to a value greater than 0x00 or ATTHOLD timing to a value greater than 0x01.

2.6 OCTOSPI

2.6.1 Spurious interrupt in AND-match polling mode with full data masking

Description

In AND-match polling mode with the MASK[31:0] bitfield set to 0x0000 0000 (all bits masked), a spurious interrupt may occur.

Workaround

Avoid setting the MASK[31:0] bitfield to 0x0000 0000.

2.6.2 Odd address alignment and odd byte number not supported at specific conditions

Description

Odd address alignment and odd transaction byte number is not supported for some combinations of memory access mode, access type, and other settings. The following table summarizes the supported combinations, and provides information on consequences of accessing an illegal address and/or of setting an illegal number of bytes in a transaction.

Table 5. Summary of supported combinations

Memory access mode / other settings ⁽¹⁾	Access type ⁽²⁾	Address allowed	Consequence of illegal address access ⁽³⁾	Byte number allowed	Consequence of illegal byte number ⁽³⁾
Single-SPI, Dual-SPI, Quad-SPI, RAM / DQM = 0 or Octo-SPI / SDR mode	ind read	any	N/A	any	N/A
	mm read	any	N/A	any	N/A
	ind write	any	N/A	any	N/A
	mm write	any	N/A	any	N/A
Single-SPI, Dual-SPI, Quad-SPI, RAM / DQM = 1 or Octo-SPI, RAM / DDR mode, no RDS, no WDM	ind read	even	ADDR[0] cleared	even	DLR[0] cleared
	mm read	any	N/A	any	N/A
	ind write	even	ADDR[0] cleared	even	DLR[0] cleared
	mm write	even	slave error	even	last byte lost
Octo-SPI, RAM / DDR mode, with RDS or WDM or HyperBus™	ind read	even	ADDR[0] cleared	even	DLR[0] cleared
	mm read	any	N/A	any	N/A
	ind write	any	N/A	any	N/A
	mm write	any	N/A	any	N/A

1. "RDS" = read data strobe, "WDM" = write data mask
2. "ind read" = indirect read, "mm read" = memory-mapped read, "ind write" = indirect write, "mm write" = memory-mapped write
3. "N/A" = not applicable

Workaround

Avoid illegal address accesses and illegal byte numbers in transactions.

2.6.3 Data not sampled correctly on reads without DQS and with less than two cycles before the data phase

Description

A command is composed of five phases:

- Command
- Address
- Alternate byte
- Dummy (latency) cycles
- Data

Data are not sampled correctly if all the following conditions are true:

- Fewer than two cycles are required by the first four phases (command, address, alternate or dummy)
- DQS is disabled (DQSE=0)
- Data phase is enabled
- Data are read in Indirect or Memory-mapped mode

Workaround

Ensure that there are at least two cycles before the data phase using one of the following methods :

- Send one byte of address in quad-SDR mode (ADMODE=011, ADSIZE=00, ADDDTR=0)
- Send two bytes of address in octal-SDR mode (ADMODE=100, ADSIZE=01, ADDDTR=0)
- Send four bytes of address in octal-DTR mode (ADMODE=100, ADSIZE=11, ADDDTR=1)
- Send two bytes of instruction in quad-DTR mode (IMODE=011, ISIZE=01, IDDTR=1)
- Send one instruction byte in octal followed by one dummy cycle.
- Send one instruction byte in octal followed by one alternate byte in octal.

2.6.4 Byte possibly dropped during an SDR read in clock mode 3 when a transfer gets automatically split

Description

When reading a continuous stream of data from sequential addresses in a serial memory, OCTOSPI can interrupt the transfer and automatically restart it at the next address when the CSBOUND, REFRESH, TIMEOUT or MAX-TRAN features are employed. Thus, a single continuous transfer can effectively be split into multiple smaller transfers.

When OCTOSPI is configured to use clock mode 3 (CKMODE bit in OCTOSPI_DCR1 is set to 1) and a continuous stream of data is read in SDR mode (CKMODE bit in OCTOSPI_DCR1 is set to 0), the last byte sent by the memory before an automatic split might get dropped, thus causing all the subsequent bytes to be seen one address earlier.

Workaround

Use clock mode 0 (CKMODE bit in OCTOSPI_DCR1 is set to 0) when in SDR mode.

2.6.5 Single, dual and quad modes not functional with DQS input enabled

Description

Data read from memory in single, dual or quad mode with the DQS input enabled (DQSE control bit in OCTOSPI_CCR is set to 1) can be corrupted. Only octal-data mode (DMODE bit in OCTOSPI_CCR is set to 100) is functional with the DQS input enabled.

Workaround

None.

2.6.6 Additional bytes read in indirect mode with DQS input enabled when data length is too short

Description

Extra bytes reception may appear when below two conditions are met at the same time:

- Data read in indirect-read mode with DQS enabled (DQSE bit in OCTOSPI_CCR set to 1)
- The number of cycles for data read phase is less than the sum of the number of cycles required for (command + address + alternate-byte + dummy) phases.

Workaround

- Avoid programming transfers with data phase shorter than (command + address + alternate-byte + dummy) phases
- Perform an abort just after reading all the data required bytes from OCTOSPI_DR register.

2.7 OCTOSPIM

2.7.1 Unaligned write access to OCTOSPIM configuration registers failing

Description

Unaligned write access to OCTOSPIM configuration registers is discarded, with hard fault. The de-assertion of *hready* AHB signal then takes three cycles, which is not compliant with the AHB standard that defines two cycles.

Workaround

Avoid unaligned write accesses to OCTOSPIM configuration registers.

2.8 ADC

2.8.1 New context conversion initiated without waiting for trigger when writing new context in ADC_JSQR with JQDIS = 0 and JQM = 0

Description

Once an injected conversion sequence is complete, the queue is consumed and the context changes according to the new ADC_JSQR parameters stored in the queue. This new context is applied for the next injected sequence of conversions.

However, the programming of the new context in ADC_JSQR (change of injected trigger selection and/or trigger polarity) may launch the execution of this context without waiting for the trigger if:

- the queue of context is enabled (JQDIS cleared to 0 in ADC_CFGR), and
- the queue is never empty (JQM cleared to 0 in ADC_CFGR), and
- the injected conversion sequence is complete and no conversion from previous context is ongoing

Workaround

Apply one of the following measures:

- Ignore the first conversion.
- Use a queue of context with JQM = 1.
- Use a queue of context with JQM = 0, only change the conversion sequence but never the trigger selection and the polarity.

2.8.2 Two consecutive context conversions fail when writing new context in ADC_JSQR just after previous context completion with JQDIS = 0 and JQM = 0

Description

When an injected conversion sequence is complete and the queue is consumed, writing a new context in ADC_JSQR just after the completion of the previous context and with a length longer than the previous context, may cause both contexts to fail. The two contexts are considered as one single context. As an example, if the first context contains element 1 and the second context elements 2 and 3, the first context is consumed followed by elements 2 and 3 and element 1 is not executed.

This issue may happen if:

- the queue of context is enabled (JQDIS cleared to 0 in ADC_CFGR), and
- the queue is never empty (JQM cleared to 0 in ADC_CFGR), and
- the length of the new context is longer than the previous one

Workaround

If possible, synchronize the writing of the new context with the reception of the new trigger.

2.8.3 Unexpected regular conversion when two consecutive injected conversions are performed in Dual interleaved mode

Description

In Dual ADC mode, an unexpected regular conversion may start at the end of the second injected conversion without a regular trigger being received, if the second injected conversion starts exactly at the same time than the end of the first injected conversion. This issue may happen in the following conditions:

- two consecutive injected conversions performed in Interleaved simultaneous mode (DUAL[4:0] of ADC_CCR = 0b00011), or
- two consecutive injected conversions from master or slave ADC performed in Interleaved mode (DUAL[4:0] of ADC_CCR = 0b00111)

Workaround

- In Interleaved simultaneous injected mode: make sure the time between two injected conversion triggers is longer than the injected conversion time.
- In Interleaved only mode: perform injected conversions from one single ADC (master or slave), making sure the time between two injected triggers is longer than the injected conversion time.

2.8.4 Wrong ADC result if conversion done late after calibration or previous conversion

Description

The result of an ADC conversion done more than 1 ms later than the previous ADC conversion or ADC calibration might be incorrect.

Workaround

Perform two consecutive ADC conversions in single, scan or continuous mode. Reject the result of the first conversion and only keep the result of the second.

2.8.5 Wrong ADC differential conversion result for channel 5

Description

The ADC (ADC1 or ADC2) configured in differential mode with the channel 5 selected provides wrong conversion result.

Workaround

Set an unused SQxx[4:0] bitfield of the corresponding ADC_SQRx register, or an unused JSQxx[4:0] bitfield of the ADC_JSQR register, to channel 6.

For example, write the SQ16[4:0] bitfield of the ADC_SQR4 register with 00110 when the L[3:0] bitfield of the ADC_SQR1 register is set to 0001.

2.9 DAC

2.9.1 Invalid DAC channel analog output if the DAC channel MODE bitfield is programmed before DAC initialization

Description

When the DAC operates in Normal mode and the DAC enable bit is cleared, writing a value different from 000 to the DAC channel MODE bitfield of the DAC_MCR register before performing data initialization causes the corresponding DAC channel analog output to be invalid.

Workaround

Apply the following sequence:

1. Perform one write access to any data register.
2. Program the MODE bitfield of the DAC_MCR register.

2.9.2 DMA underrun flag not set when an internal trigger is detected on the clock cycle of the DMA request acknowledge

Description

When the DAC channel operates in DMA mode (DMAEN of DAC_CR register set), the DMA channel underrun flag (DMAUDR of DAC_SR register) fails to rise upon an internal trigger detection if that detection occurs during the same clock cycle as a DMA request acknowledge. As a result, the user application is not informed that an underrun error occurred.

This issue occurs when software and hardware triggers are used concurrently to trigger DMA transfers.

Workaround

None.

2.10 COMP

2.10.1 Comparator outputs cannot be configured in open-drain

Description

Comparator outputs are always forced in push-pull mode whatever the GPIO output type configuration bit value.

Workaround

None.

2.11 HASH

2.11.1 Superseded suspend sequence for data loaded by DMA

Description

The section *HASH / Context swapping / Data loaded by DMA / Current context saving* of some reference manual revisions may suggest the following suspend sequence for using HASH with DMA:

1. Clear the DMAE bit to disable the DMA interface.
2. Wait until the current DMA transfer is complete (wait for DMAS = 0 in the HASH_SR register).

This recommendation is obsolete and superseded with the following sequence that suspends then resumes the secure digest computing in order to swap the context:

Suspend:

1. In Polling mode, wait for BUSY = 0. If the DCIS bit of the HASH_SR register is set, the hash result is available and the context swapping is useless. Otherwise, go to step 2.
2. In Polling mode, wait for BUSY = 1.
3. Disable the DMA channel. Then clear the DMAE bit of the HASH_CR register.
4. In Polling mode, wait for BUSY = 0. If the DCIS bit of the HASH_SR register is set, the hash result is available and the context swapping is useless. Otherwise, go to step 5.
5. Save the HASH_IMR, HASH_STR, HASH_CR, and HASH_CSR0 to HASH_CSR37 registers. The HASH_CSR38 to HASH_CSR53 registers must also be saved if an HMAC operation is ongoing.

Resume:

1. Reconfigure the DMA controller so that it proceeds with the transfer of the message up to the end if it is not interrupted again. Do not forget to take into account the words already pushed into the FIFO if NBW[3:0] is higher than 0x0.
2. Program the values saved in memory to the HASH_IMR, HASH_STR, and HASH_CR registers.
3. Initialize the hash processor by setting the INIT bit of the HASH_CR register.
4. Program the values saved in memory to the HASH_CSRx registers.
5. Restart the processing from the point of interruption, by setting the DMAE bit.

Note: To optimize the resume process when NBW[3:0] = 0x0, HASH_CSR22 to HASH_CSR37 registers do not need to be saved then restored as the FIFO is empty.

This is a documentation issue rather than a product limitation.

Workaround

No application workaround is required as long as the new sequence is applied.

2.11.2 Superseded suspend sequence for data loaded by the CPU

Description

The section *HASH / Context swapping / Data loaded by software* of some reference manual revisions may instruct that “the user application must wait until DINIS ≠ 1 (last block processed and input FIFO empty) or NBW 0 (FIFO not full and no processing ongoing)”.

This instruction is obsolete and superseded with the following:

When the DMA is not used to load the message into the hash processor, the context can be saved only when no block processing is ongoing.

To suspend the processing of a message, proceed as follows after writing 16 words 32-bit (plus one if it is the first block):

1. In Polling mode, wait for BUSY = 0, then poll if the DINIS status bit is set to 1. In Interrupt mode, implement the next step in DINIS interrupt handler (recommended).
2. Store the contents of the following registers into memory:
 - HASH_IMR
 - HASH_STR
 - HASH_CR
 - HASH_CSR0 to HASH_CSR37 and, if an HMAC operation is ongoing, also HASH_CSR38 to HASH_CSR53

To resume the processing of a message, proceed as follows:

1. Write the HASH_IMR, HASH_STR, and HASH_CR registers with the values saved in memory.
2. Initialize the hash processor by setting the INIT bit of the HASH_CR register.
3. Write the HASH_CSRx registers with the values saved in memory.
4. Restart the processing from the point of interruption.

Note: To optimize the resume process when NBW[3:0]=0x0, HASH_CSR22 to HASH_CSR37 registers do not need to be saved then restored as the FIFO is empty.

This is a documentation issue rather than a product limitation.

Workaround

No application workaround is required as long as the new sequence is applied.

2.12 TIM

2.12.1 One-pulse mode trigger not detected in master-slave reset + trigger configuration

Description

The failure occurs when several timers configured in one-pulse mode are cascaded, and the master timer is configured in combined reset + trigger mode with the MSM bit set:

OPM = 1 in TIMx_CR1, SMS[3:0] = 1000 and MSM = 1 in TIMx_SMCR.

The MSM delays the reaction of the master timer to the trigger event, so as to have the slave timers cycle-accurately synchronized.

If the trigger arrives when the counter value is equal to the period value set in the TIMx_ARR register, the one-pulse mode of the master timer does not work and no pulse is generated on the output.

Workaround

None. However, unless a cycle-level synchronization is mandatory, it is advised to keep the MSM bit reset, in which case the problem is not present. The MSM = 0 configuration also allows decreasing the timer latency to external trigger events.

2.12.2 HSE/32 is not available for TIM16 input capture if RTC clock is disabled or other than HSE

Description

If the RTC clock is either disabled or other than HSE, the HSE/32 clock is not available for TIM16 input capture even if selected (bitfield TI1_RMP[2:0] = 101 in the TIM16_OR1 register).

Workaround

Apply the following procedure:

1. Enable the power controller clock (bit PWREN = 1 in the RCC_APB1ENR1 register).
2. Disable the backup domain write protection (bit DBP = 0 in the PWR_CR1 register).
3. Enable RTC clock and select HSE as clock source for RTC (bits RTCSEL[1:0] = 11 and bit RTCEN = 1 in the RCC_BDCR register).
4. Select the HSE/32 as input capture source for TIM16 (bitfield TI1_RMP[2:0] = 101 in the TIM16_OR1 register).

Alternatively, use TIM17 that implements the same features as TIM16, and is not affected by the limitation described.

2.13 LPTIM

2.13.1 MCU may remain stuck in LPTIM interrupt when entering Stop mode

Description

This limitation occurs when disabling the low-power timer (LPTIM).

When the user application clears the ENABLE bit in the LPTIM_CR register within a small time window around one LPTIM interrupt occurrence, then the LPTIM interrupt signal used to wake up the MCU from Stop mode may be frozen in active state. Consequently, when trying to enter Stop mode, this limitation prevents the MCU from entering low-power mode and the firmware remains stuck in the LPTIM interrupt routine.

This limitation applies to all Stop modes and to all instances of the LPTIM. Note that the occurrence of this issue is very low.

Workaround

In order to disable a low power timer (LPTIMx) peripheral, do not clear its ENABLE bit in its respective LPTIM_CR register. Instead, reset the whole LPTIMx peripheral via the RCC controller by setting and resetting its respective LPTIMxRST bit in RCC_APBxRSTRz register.

2.13.2 ARR and CMPM flags are not set when APB clock is slower than kernel clock

Description

When LPTIM is configured in one shot mode and APB clock is lower than kernel clock, there is a chance that ARR and CMPM flags are not set at the end of the counting cycle defined by the repetition value REP[7:0]. This issue can only occur when the repetition counter is configured with an odd repetition value.

Workaround

To avoid this issue the following formula must be respected:

$$\{ARR, CMP\} \geq KER_CLK / (2 * APB_CLK),$$

where APB_CLK is the LPTIM APB clock frequency, and KER_CLK is the LPTIM kernel clock frequency. ARR and CMP are expressed in decimal value.

Example: The following example illustrates a configuration where the issue can occur:

- APB clock source (MSI) = 1 MHz , Kernel clock source (HSI) = 16 MHz
- Repetition counter is set with REP[7:0] = 0x3 (odd value)

The above example is subject to issue, unless the user respects:

$$\{CMP, ARR\} \geq 16 \text{ MHz} / (2 * 1 \text{ MHz})$$

→ ARR must be ≥ 8 and CMP must be ≥ 8

Note: REP set to 0x3 means that effective repetition is REP+1 (= 4) but the user must consider the parity of the value loaded in LPTIM_RCR register (=3, odd) to assess the risk of issue.

2.13.3 MCU may remain stuck in LPTIM interrupt when clearing event flag

Description

This limitation occurs when the LPTIM is configured in interrupt mode (at least one interrupt is enabled) and the software clears any flag by writing the LPTIM_ICR bit in the LPTIM_ISR register. If the interrupt status flag corresponding to a disabled interrupt is cleared simultaneously with a new event detection, the set and clear commands might reach the APB domain at the same time, leading to an asynchronous interrupt signal permanently stuck high.

This issue can occur either during an interrupt subroutine execution (where the flag clearing is usually done), or outside an interrupt subroutine.

Consequently, the firmware remains stuck in the LPTIM interrupt routine, and the MCU cannot enter Stop mode.

Workaround

To avoid this issue, it is strongly advised to follow the recommendations listed below:

- Clear the flag only when its corresponding interrupt is enabled in the interrupt enable register.
- If for specific reasons, it is required to clear some flags that have corresponding interrupt lines disabled in the interrupt enable register, it is recommended to clear them during the current subroutine prior to those which have corresponding interrupt line enabled in the interrupt enable register.
- Flags must not be cleared outside the interrupt subroutine.

Note: The proper clear sequence is already implemented in the HAL_LPTIM_IRQHandler in the STM32Cube.

2.13.4 LPTIM1 outputs cannot be configured as open-drain

Description

LPTIM1 outputs are set in push-pull mode regardless of the configuration of corresponding GPIO outputs.

Workaround

None.

2.14 RTC and TAMP

2.14.1 Alarm flag may be repeatedly set when the core is stopped in debug

Description

When the core is stopped in debug mode, the clock is supplied to subsecond RTC alarm downcounter even though the device is configured to stop the RTC in debug.

As a consequence, when the subsecond counter is used for alarm condition (the MASKSS[3:0] bitfield of the RTC_ALRMASR and/or RTC_ALRMBSSR register set to a non-zero value) and the alarm condition is met just before entering a breakpoint or printf, the ALRAF and/or ALRBF flag of the RTC_SR register is repeatedly set by hardware during the breakpoint or printf, which makes any tentative to clear the flag(s) ineffective.

Workaround

None.

2.14.2 RTC_REFIN and RTC_OUT on PB2 not operating in Stop 2 mode

Description

In Stop 2 low-power mode, the RTC_REFIN function does not operate and the RTC_OUT function does not operate if mapped on the PB2 pin.

Workaround

Apply one of the following measures:

- Use Stop 1 mode instead of Stop 2. This ensures the operation of both functions.
- Map RTC_OUT to the PC13 pin. This ensures the operation of the RTC_OUT function in either low-power mode. However, it has no effect to the RTC_REFIN function.

2.15 I2C

2.15.1 Wrong data sampling when data setup time ($t_{SU;DAT}$) is shorter than one I2C kernel clock period

Description

The I²C-bus specification and user manual specify a minimum data setup time ($t_{SU;DAT}$) as:

- 250 ns in Standard mode
- 100 ns in Fast mode
- 50 ns in Fast mode Plus

The MCU does not correctly sample the I²C-bus SDA line when $t_{SU;DAT}$ is smaller than one I2C kernel clock (I²C-bus peripheral clock) period: the previous SDA value is sampled instead of the current one. This can result in a wrong receipt of slave address, data byte, or acknowledge bit.

Workaround

Increase the I2C kernel clock frequency to get I2C kernel clock period within the transmitter minimum data setup time. Alternatively, increase transmitter's minimum data setup time. If the transmitter setup time minimum value corresponds to the minimum value provided in the I²C-bus standard, the minimum I2CCLK frequencies are as follows:

- In Standard mode, if the transmitter minimum setup time is 250 ns, the I2CCLK frequency must be at least 4 MHz.
- In Fast mode, if the transmitter minimum setup time is 100 ns, the I2CCLK frequency must be at least 10 MHz.
- In Fast-mode Plus, if the transmitter minimum setup time is 50 ns, the I2CCLK frequency must be at least 20 MHz.

2.15.2 Spurious bus error detection in master mode

Description

In master mode, a bus error can be detected spuriously, with the consequence of setting the BERR flag of the I2C_SR register and generating bus error interrupt if such interrupt is enabled. Detection of bus error has no effect on the I²C-bus transfer in master mode and any such transfer continues normally.

Workaround

If a bus error interrupt is generated in master mode, the BERR flag must be cleared by software. No other action is required and the ongoing transfer can be handled normally.

2.15.3 OVR flag not set in underrun condition

Description

In slave transmission with clock stretching disabled (NOSTRETCH = 1 in the I2C_CR1 register), an underrun condition occurs if the current byte transmission is completed on the I2C bus, and the next data is not yet written in the TXDATA[7:0] bitfield. In this condition, the device is expected to set the OVR flag of the I2C_ISR register and send 0xFF on the bus.

However, if the I2C_TXDR is written within the interval between two I2C kernel clock cycles before and three APB clock cycles after the start of the next data transmission, the OVR flag is not set, although the transmitted value is 0xFF.

Workaround

None.

2.15.4 Transmission stalled after first byte transfer

Description

When the first byte to transmit is not prepared in the TXDATA register, two bytes are required successively, through TXIS status flag setting or through a DMA request. If the first of the two bytes is written in the I2C_TXDR register in less than two I2C kernel clock cycles after the TXIS/DMA request, and the ratio between APB clock and I2C kernel clock frequencies is between 1.5 and 3, the second byte written in the I2C_TXDR is not internally detected. This causes a state in which the I2C peripheral is stalled in master mode or in slave mode, with clock stretching enabled (NOSTRETCH = 0). This state can only be released by disabling the peripheral (PE = 0) or by resetting it.

Workaround

Apply one of the following measures:

- Write the first data in I2C_TXDR before the transmission starts.
- Set the APB clock frequency so that its ratio with respect to the I2C kernel clock frequency is lower than 1.5 or higher than 3.

2.16 USART

2.16.1 Anticipated end-of-transmission signaling in SPI slave mode

Description

In SPI slave mode, at low USART baud rate with respect to the USART kernel and APB clock frequencies, the *transmission complete* flag TC of the USARTx_ISR register may unduly be set before the last bit is shifted on the transmit line.

This leads to data corruption if, based on this anticipated end-of-transmission signaling, the application disables the peripheral before the last bit is transmitted.

Workaround

Upon the TC flag rise, wait until the clock line remains idle for more than the half of the communication clock cycle. Then only consider the transmission as ended.

2.16.2 Data corruption due to noisy receive line

Description

In UART mode with oversampling by 8 or 16 and with 1 or 2 stop bits, the received data may be corrupted if a glitch to zero shorter than the half-bit occurs on the receive line within the second half of the stop bit.

Workaround

None.

2.17 LPUART

2.17.1 LPUART1 outputs cannot be configured as open-drain

Description

LPUART1 outputs are set in push-pull mode regardless of the configuration of corresponding GPIO outputs.

Workaround

None.

2.18 SPI

2.18.1 BSY bit may stay high when SPI is disabled

Description

The BSY flag may remain high upon disabling the SPI while operating in:

- master transmit mode and the TXE flag is low (data register full).
- master receive-only mode (simplex receive or half-duplex bidirectional receive phase) and an SCK strobing edge has not occurred since the transition of the RXNE flag from low to high.
- slave mode and NSS signal is removed during the communication.

Workaround

When the SPI operates in:

- master transmit mode, disable the SPI when TXE = 1 and BSY = 0.
- master receive-only mode, ignore the BSY flag.
- slave mode, do not remove the NSS signal during the communication.

2.18.2 BSY bit may stay high at the end of data transfer in slave mode

Description

BSY flag may sporadically remain high at the end of a data transfer in slave mode. This occurs upon coincidence of internal CPU clock and external SCK clock provided by master.

In such an event, if the software only relies on BSY flag to detect the end of SPI slave data transaction (for example to enter low-power mode or to change data line direction in half-duplex bidirectional mode), the detection fails.

As a conclusion, the BSY flag is unreliable for detecting the end of data transactions.

Workaround

Depending on SPI operating mode, use the following means for detecting the end of transaction:

- When NSS hardware management is applied and NSS signal is provided by master, use NSS flag.
- In SPI receiving mode, use the corresponding RXNE event flag.
- In SPI transmit-only mode, use the BSY flag in conjunction with a timeout expiry event. Set the timeout such as to exceed the expected duration of the last data frame and start it upon TXE event that occurs with the second bit of the last data frame. The end of the transaction corresponds to either the BSY flag becoming low or the timeout expiry, whichever happens first.

Prefer one of the first two measures to the third as they are simpler and less constraining.

Alternatively, apply the following sequence to ensure reliable operation of the BSY flag in SPI transmit mode:

1. Write last data to data register.
2. Poll the TXE flag until it becomes high, which occurs with the second bit of the data frame transfer.
3. Disable SPI by clearing the SPE bit mandatorily before the end of the frame transfer.
4. Poll the BSY bit until it becomes low, which signals the end of transfer.

Note: The alternative method can only be used with relatively fast CPU speeds versus relatively slow SPI clocks or/and long last data frames. The faster is the software execution, the shorter can be the duration of the last data frame.

2.19 SAI

2.19.1 Last SAI_MCLK clock pulse truncated upon disabling SAI master

Description

When disabling, during the communication, the SAI peripheral configured as master with the OUTDRIV bit of the corresponding SAI_xCR1 register cleared, the device may truncate the last SAI_MCLK_x bit clock pulse of the transaction, potentially causing a failure to the external codec logic.

Workaround

Set the OUTDRIV bit of the corresponding SAI_xCR1 register.

2.20 bxCAN

2.20.1 bxCAN time-triggered communication mode not supported

Description

The time-triggered communication mode described in the reference manual is not supported. As a result, timestamp values are not available. The TTCM bit of the CAN_MCR register must be kept cleared (time-triggered communication mode disabled).

Workaround

None.

2.21 OTG_FS

2.21.1 Host packet transmission may hang when connecting through a hub to a low-speed device

Description

When the USB on-the-go full-speed peripheral connects to a low-speed device via a hub, the transmitter internal state machine may hang. This leads, after a timeout expiry, to a port disconnect interrupt.

Workaround

None. However, increasing the capacitance on the data lines may reduce the occurrence.

Revision history

Table 6. Document revision history

Date	Version	Changes
16-Dec-2019	1	Initial release.
09-Mar-2020	2	Added errata in Section 1 Summary of device errata and Section 2 Description of device errata: <ul style="list-style-type: none"> • Unaligned write access to OCTOSPIM configuration registers failing • Wrong ADC differential conversion result for channel 5 • Anticipated end-of-transmission signaling in SPI slave mode • Data corruption due to noisy receive line • Superseded suspend sequence for data loaded by DMA • Superseded suspend sequence for data loaded by the CPU Added Table 4. Summary of device documentation errata.

Contents

1	Summary of device errata	2
2	Description of device errata	4
2.1	Core	4
2.1.1	Interrupted loads to SP can cause erroneous behavior	4
2.2	System	4
2.2.1	Full JTAG configuration without NJTRST pin cannot be used	4
2.2.2	Data cache might be corrupted during Flash memory read-while-write operation	5
2.2.3	HSE oscillator long startup at low voltage	5
2.2.4	FLASH_ECCR corrupted upon reset or power-down occurring during Flash memory program or erase operation	5
2.3	DMA	6
2.3.1	DMA disable failure and error flag omission upon simultaneous transfer error and global flag clear	6
2.4	DMAMUX	6
2.4.1	SOFx not asserted when writing into DMAMUX_CFR register	6
2.4.2	OFx not asserted for trigger event coinciding with last DMAMUX request	6
2.4.3	OFx not asserted when writing into DMAMUX_RGCFR register	7
2.4.4	Wrong input DMA request routed upon specific DMAMUX_CxCR register write coinciding with synchronization event	7
2.5	FMC	7
2.5.1	Dummy read cycles inserted when reading synchronous memories	7
2.5.2	Wrong data read from a busy NAND memory	7
2.6	OCTOSPI	8
2.6.1	Spurious interrupt in AND-match polling mode with full data masking	8
2.6.2	Odd address alignment and odd byte number not supported at specific conditions	8
2.6.3	Data not sampled correctly on reads without DQS and with less than two cycles before the data phase	9
2.6.4	Byte possibly dropped during an SDR read in clock mode 3 when a transfer gets automatically split	9
2.6.5	Single, dual and quad modes not functional with DQS input enabled	9
2.6.6	Additional bytes read in indirect mode with DQS input enabled when data length is too short	10
2.7	OCTOSPIM	10

2.7.1	Unaligned write access to OCTOSPIM configuration registers failing	10
2.8	ADC	10
2.8.1	New context conversion initiated without waiting for trigger when writing new context in ADC_JSQR with JQDIS = 0 and JQM = 0	10
2.8.2	Two consecutive context conversions fail when writing new context in ADC_JSQR just after previous context completion with JQDIS = 0 and JQM = 0	11
2.8.3	Unexpected regular conversion when two consecutive injected conversions are performed in Dual interleaved mode	11
2.8.4	Wrong ADC result if conversion done late after calibration or previous conversion	11
2.8.5	Wrong ADC differential conversion result for channel 5	11
2.9	DAC	12
2.9.1	Invalid DAC channel analog output if the DAC channel MODE bitfield is programmed before DAC initialization	12
2.9.2	DMA underrun flag not set when an internal trigger is detected on the clock cycle of the DMA request acknowledge	12
2.10	COMP	12
2.10.1	Comparator outputs cannot be configured in open-drain	12
2.11	HASH	12
2.11.1	Superseded suspend sequence for data loaded by DMA	12
2.11.2	Superseded suspend sequence for data loaded by the CPU	13
2.12	TIM	14
2.12.1	One-pulse mode trigger not detected in master-slave reset + trigger configuration	14
2.12.2	HSE/32 is not available for TIM16 input capture if RTC clock is disabled or other than HSE	14
2.13	LPTIM	14
2.13.1	MCU may remain stuck in LPTIM interrupt when entering Stop mode	14
2.13.2	ARRM and CMPM flags are not set when APB clock is slower than kernel clock	15
2.13.3	MCU may remain stuck in LPTIM interrupt when clearing event flag	15
2.13.4	LPTIM1 outputs cannot be configured as open-drain	15
2.14	RTC and TAMP	16
2.14.1	Alarm flag may be repeatedly set when the core is stopped in debug	16
2.14.2	RTC_REFIN and RTC_OUT on PB2 not operating in Stop 2 mode	16
2.15	I2C	16
2.15.1	Wrong data sampling when data setup time ($t_{SU;DAT}$) is shorter than one I2C kernel clock period	16

2.15.2	Spurious bus error detection in master mode	17
2.15.3	OVR flag not set in underrun condition	17
2.15.4	Transmission stalled after first byte transfer	17
2.16	USART	18
2.16.1	Anticipated end-of-transmission signaling in SPI slave mode	18
2.16.2	Data corruption due to noisy receive line	18
2.17	LPUART	18
2.17.1	LPUART1 outputs cannot be configured as open-drain	18
2.18	SPI	18
2.18.1	BSY bit may stay high when SPI is disabled	18
2.18.2	BSY bit may stay high at the end of data transfer in slave mode	19
2.19	SAI	19
2.19.1	Last SAI_MCLK clock pulse truncated upon disabling SAI master	19
2.20	bxCAN	19
2.20.1	bxCAN time-triggered communication mode not supported	19
2.21	OTG_FS	20
2.21.1	Host packet transmission may hang when connecting through a hub to a low-speed device	20
Revision history	21

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST’s terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2020 STMicroelectronics – All rights reserved